



(P/N)	(STUD)	(H DIA)	(INS. DIA)
型番	サイズ	H-J法	被覆外径
171506-1	#8	4.34	2.03~3.18
-2	#10	5.00	2.03~3.18
-3	#8	4.34	2.67~3.56
-4	#10	5.00	2.67~3.56
OBSELETE -5	#12	5.66	2.03~3.18
-6	特別	5.79	2.67~3.56
-7	5mm	5.26	2.03~3.18
-8	5mm	5.26	2.67~3.56
OBSELETE 171506-9	#6	3.68	2.03~3.18

DIMENSIONS IN MM DO NOT SCALE PRINT

参考図面
(CUSTOMER COPY
REFERENCE ONLY)

AMP (JAPAN), LTD.
Tokyo, Japan

D1	OBSELETE (F17-0514 F.N 47)	6-16-93
D	REVISED (REV-B)	7-4-93
C	REVISED (REV-B)	5-0-93
B	ADDED MARK	4-15-93
A	REVISED (REV-B)	7-1-93
O	ORIGINAL	1-17-92
LTR	REVISION RECORD	DR. CHK. DATE

MATERIAL	有光銅
WIRE RANGE	0.26 ~ 1.04 mm AWG22-18
INSULATION DIA.	表参照
TOLERANCE	±0.4 EXCEPT AS NOTED
SCALE	1:1
LOC	JAC-171506
REV	D1

丸型端子 RING TERMINAL